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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/939,356	08/24/2001	Francis Edward Fisher	4136-212	3461
7	590 12/01/2003		EXAMINER	
Edward M. Weisz, Esq. Cohen, Pontani, Lieberman & Pavane 551 Fifth Avenue, Suite 1210			LEO, LEONARD R	
			ART UNIT	PAPER NUMBER
New York, NY 10176			3753	
			DATE MAILED: 12/01/2003	3 (/

Please find below and/or attached an Office communication concerning this application or proceeding.

			1.1.1
	Application No.	Applicant(s)	
Advisory Action	09/939,356	FISHER ET AL.	
	Examiner	Art Unit	
	Leonard R. Leo	3753	
The MAILING DATE of this communication	on appears on the cover sheet wit	h the correspondence add	iress
THE REPLY FILED 06 November 2003 FAILS To Therefore, further action by the applicant is requiring in rejection under 37 CFR 1.113 may only be econdition for allowance; (2) a timely filed Notice of Examination (RCE) in compliance with 37 CFR 1.	ed to avoid abandonment of this ither: (1) a timely filed amendme f Appeal (with appeal fee); or (3)	application. A proper rent which places the appli	ply to a cation in
PERIOD F	OR REPLY (check either a) or b)]	
a) The period for reply expiresmonths from the b) The period for reply expires on: (1) the mailing date of event, however, will the statutory period for reply expired ONLY CHECK THIS BOX WHEN THE FIRST REPLY 706.07(f).	f this Advisory Action, or (2) the date set for re later than SIX MONTHS from the mailing	g date of the final rejection.	
Extensions of time may be obtained under 37 CFR 1.136(a) have been filed is the date for purposes of determining the period 37 CFR 1.17(a) is calculated from: (1) the expiration date of the sb) above, if checked. Any reply received by the Office later than earned patent term adjustment. See 37 CFR 1.704(b).	l of extension and the corresponding amou shortened statutory period for reply original	nt of the fee. The appropriate ex y set in the final Office action; or	tension fee under (2) as set forth in
 A Notice of Appeal was filed on Application Application CFR 1.192(a), or any extension thereof 		•	
2. The proposed amendment(s) will not be en	tered because:		
(a) they raise new issues that would require	re further consideration and/or se	earch (see NOTE below);	
(b) they raise the issue of new matter (see	e Note below);		
(c) they are not deemed to place the appli issues for appeal; and/or	cation in better form for appeal t	by materially reducing or	simplifying the
(d) they present additional claims without NOTE:	canceling a corresponding number	per of finally rejected clai	ms.
3. Applicant's reply has overcome the following	ng rejection(s):		
 Newly proposed or amended claim(s) canceling the non-allowable claim(s). 	_ would be allowable if submitted	in a separate, timely file	ed amendment
5. ☐ The a) ☐ affidavit, b) ☐ exhibit, or c) ☐ req application in condition for allowance beca		n considered but does N	OT place the
6. The affidavit or exhibit will NOT be consideraised by the Examiner in the final rejection		DLELY to issues which we	ere newly
 For purposes of Appeal, the proposed ame explanation of how the new or amended cl 	ndment(s) a) will not be entere		and an
The status of the claim(s) is (or will be) as f	follows:		
Claim(s) allowed:			
Claim(s) objected to:			
Claim(s) rejected:			
Claim(s) withdrawn from consideration:			
8. The drawing correction filed on is a)	approved or b) disapprov	ed by the Examiner.	
9. Note the attached Information Disclosure S	statement(s)(PTO-1449) Paper N	lo(s)	
10. Other:		Leond A of	la
		Leonard R. Leo Primary Examiner	

Continuation of 5. does NOT place the application in condition for allowance because:

Applicants' remarks with respect to Bollesen are correct. However, Bollesen (column 5, lines 63-65) discloses the thermal pad 16 may be omitted. Therefore, element 112 is read as the "heat sink."

Applicants' remarks with respect to Villaume are correct. However, the entire underside surface 24 of heat sink 10 is "coplanar" with and contacting discrete elements 50 (Figures 2-3).

Applicants' remarks with respect to Takahashi are mistaken. Figures 4A and 4B are perspective views of the embodiment of Figure 3, which clearly discloses discrete elements 1 mounted on the circuit board 3. Any structure of the corrugated heat sink 9 mechanically fixed to one discrete element and not the other discrete element is read as a "land."

Applicants' remarks with respect to Pavlovic are disheartening. The Examiner regrets any confusion applicants may have encountered. Figures 3-4 of Pavlovic show a cross-section of the heat sink 24 composed of a single sheet 32 having deformed fins 40, 42 extending on opposing sides of the heat sink. As disclosed in Figure 1, a plurality of discrete elements 18 are to be mechanically fixed to lands 46 of respective heat sink fins 40.

Applicants' remarks with respect to Katsui are not well taken. Applicants acknowledge Katsui discloses IC packages 4 and 6, yet fails to recognize the elements are "discrete." The Examiner would like to know what applicants believe the word "discrete" means. Discrete, by definition, means separate or distinct. IC packages 4 and 6 are clearly separate and distinct from one another.

The rejections in view of the secondary references of Rosenbaum and Pei et al are deemed correct for lack of any arguments to the contrary. Applicants merely state the secondary references do not disclose or teach what the primary reference allegedly lacks. Therefore, the respective teachings and motivations are deemed proper.